

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

|                                      |   |                   |
|--------------------------------------|---|-------------------|
| In re application of:                | ) | Examiner: Unknown |
|                                      | ) | Art Unit: Unknown |
| Chakravorty et al.                   | ) |                   |
|                                      | ) |                   |
| Serial No: Unassigned                | ) |                   |
|                                      | ) |                   |
| Filed: May 3, 2004                   | ) |                   |
|                                      | ) |                   |
| Continuation Application of          | ) |                   |
| Serial No. 10/158,250                | ) |                   |
| Filed: May 30, 2002                  | ) |                   |
|                                      | ) |                   |
| For: A FLIP-CHIP PACKAGE INTEGRATING | ) |                   |
| OPTICAL AND ELECTRICAL DEVICES       | ) |                   |
| AND COUPLING TO A WAVEGUIDE ON A     | ) |                   |
| <u>BOARD</u>                         | ) |                   |

**PRELIMINARY AMENDMENT**

Hon. Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Prior to examination of the above-identified application, please enter the following preliminary amendment and consider the remarks.

///

///

///

///